

### Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	$I_D$
20V	22mΩ@4.5V	6A
	30mΩ@2.5V	
-20V	50mΩ@4.5V	-5A
	70mΩ@2.5V	

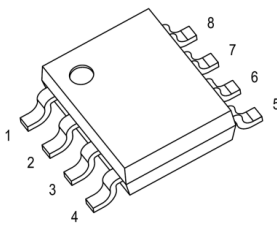
### Feature

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Fast Switching Speed

### Application

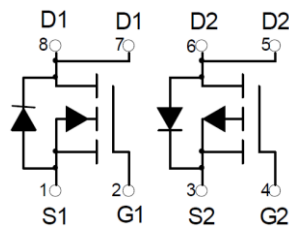
- Motor Control
- Power Management Functions
- DC-DC Converters
- Back lighting

### Package

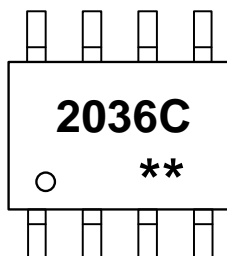


SOP-8L

### Circuit diagram



### Marking



2036C: Product code  
\*\* : Week code.

**Maximum Ratings-Total Device(Ta=25°C unless otherwise noted)**

Parameter	Symbol	Value	Unit
Storage Temperature	T <sub>STG</sub>	-55~ +150	°C

**Maximum Ratings - N-Channel Q1(Ta=25°C unless otherwise noted)**

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DS</sub>	20	V
Gate-Source Voltage	V <sub>GS</sub>	±12	V
Continuous Drain Current	I <sub>D</sub>	6	A

**Maximum Ratings - P-Channel Q1(Ta=25°C unless otherwise noted)**

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DS</sub>	-20	V
Gate-Source Voltage	V <sub>GS</sub>	±12	V
Continuous Drain Current	I <sub>D</sub>	-5	A

**Thermal Characteristics**

Parameter	Symbol	Value	Unit
Thermal Resistance from Junction to Ambient	R <sub>θJA</sub>	277	°C/W

**Electrical characteristics - N-Channel Q1 (T<sub>A</sub>=25 °C, unless otherwise noted)**

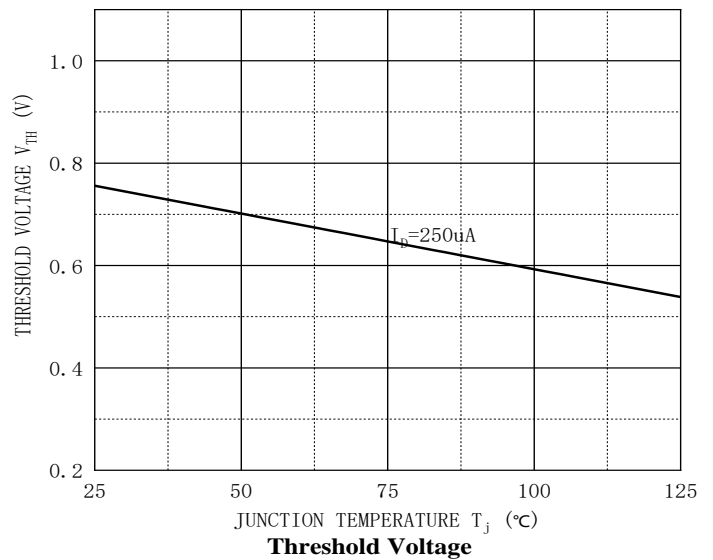
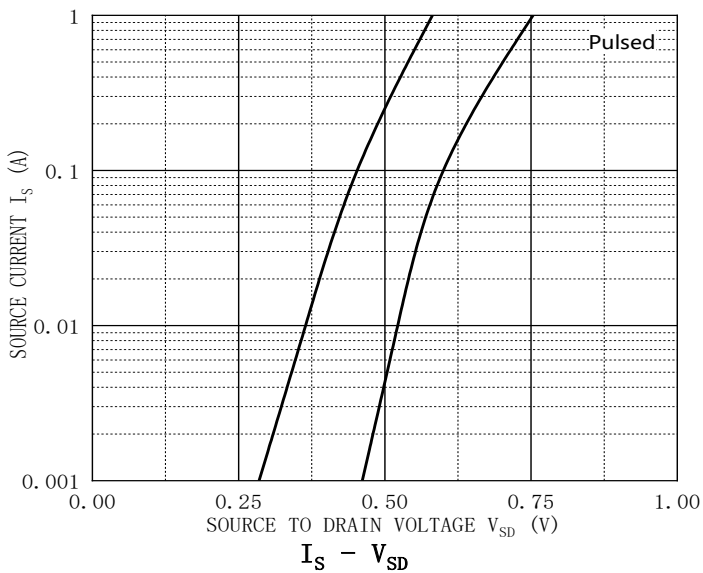
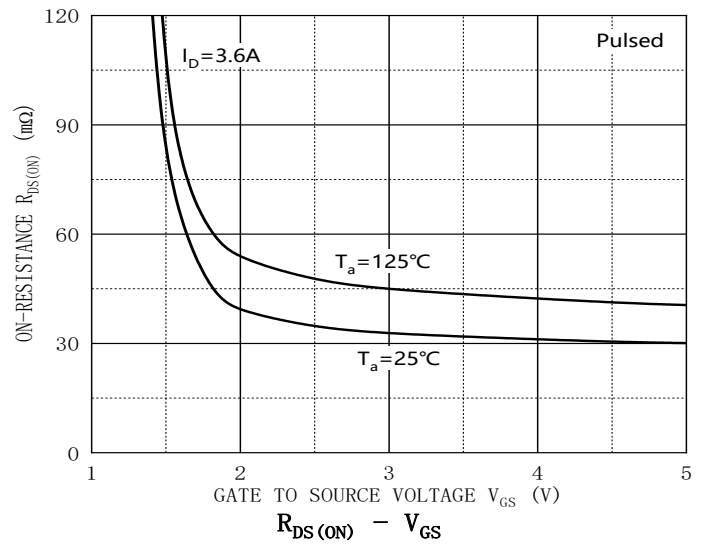
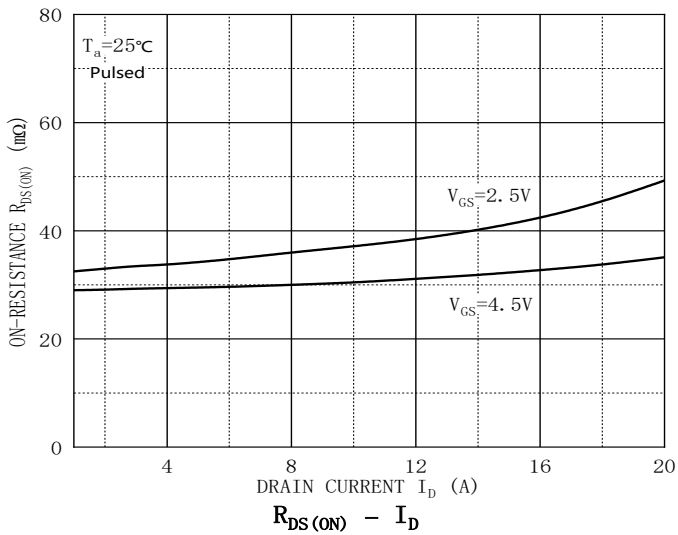
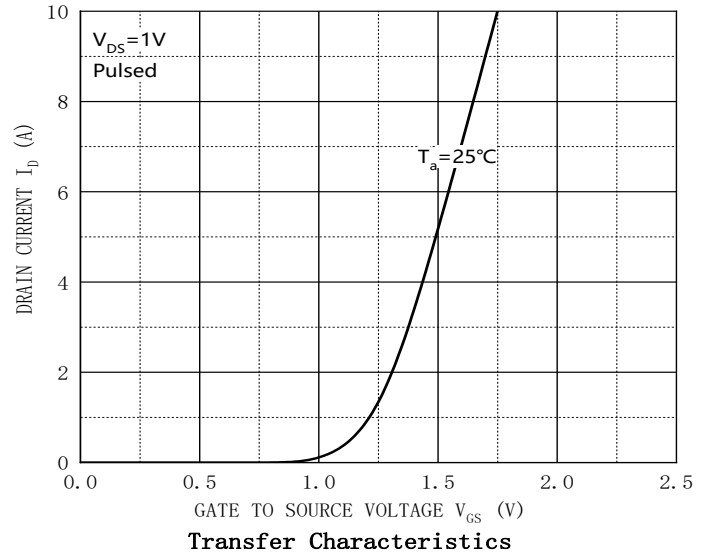
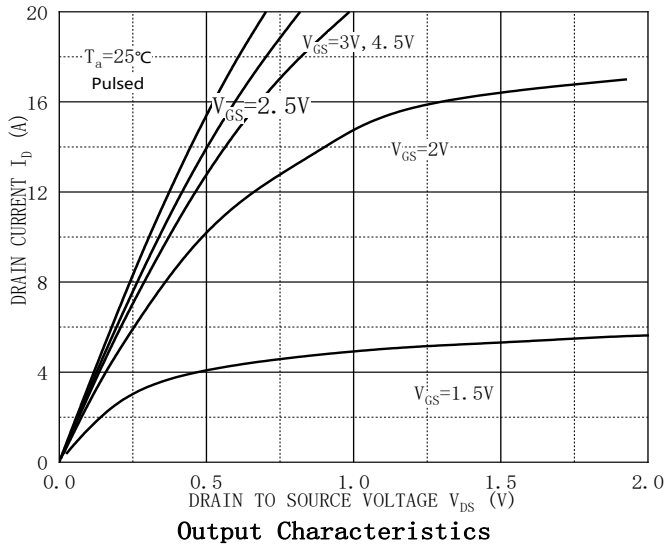
Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
<b>Static Characteristics</b>						
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> =250μA	20			V
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> =20V, V <sub>GS</sub> = 0V			1	μA
Gate-body leakage current	I <sub>GSS</sub>	V <sub>GS</sub> =±12V, V <sub>DS</sub> = 0V			±0.1	μA
Gate threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	0.5	0.7	1	V
Drain-source on-resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =4A		22	30	mΩ
		V <sub>GS</sub> =2.5V, I <sub>D</sub> =3A		30	40	
<b>Dynamic characteristics</b>						
Total gate charge	Q <sub>g</sub>	V <sub>DS</sub> =10V, V <sub>GS</sub> =4.5V, I <sub>D</sub> =4A		11		nC
Gate-source charge	Q <sub>gs</sub>			2.3		
Gate-drain charge	Q <sub>gd</sub>			2.5		
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =8V, V <sub>GS</sub> =0V, f=1MHz		800		pF
Output Capacitance	C <sub>oss</sub>			155		
Reverse Transfer Capacitance	C <sub>rss</sub>			125		
<b>Switching Characteristics</b>						
Turn-on delay time	t <sub>d(on)</sub>	V <sub>DD</sub> =10V, V <sub>GS</sub> =4V, I <sub>D</sub> =1A R <sub>G</sub> =10Ω		18		ns
Turn-on rise time	t <sub>r</sub>			5		
Turn-off delay time	t <sub>d(off)</sub>			43		
Turn-off fall time	t <sub>f</sub>			20		

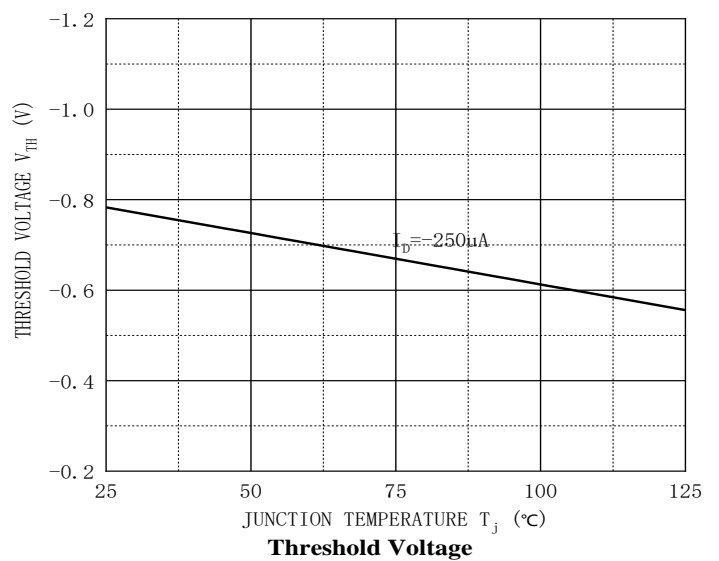
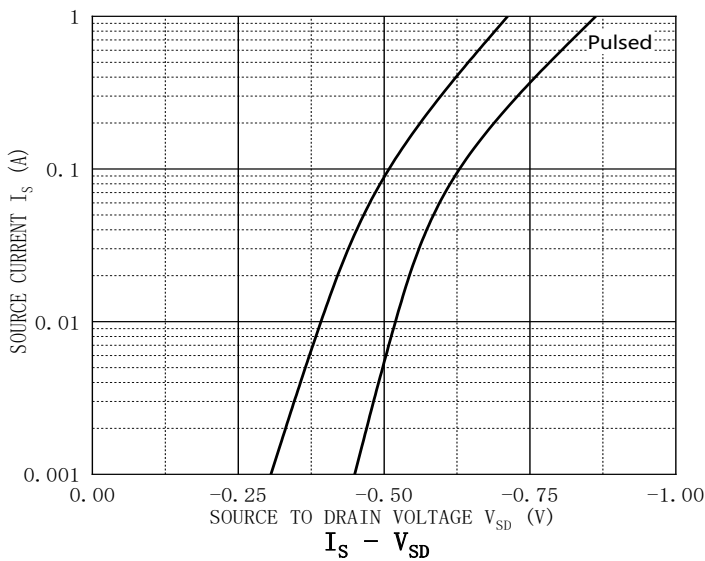
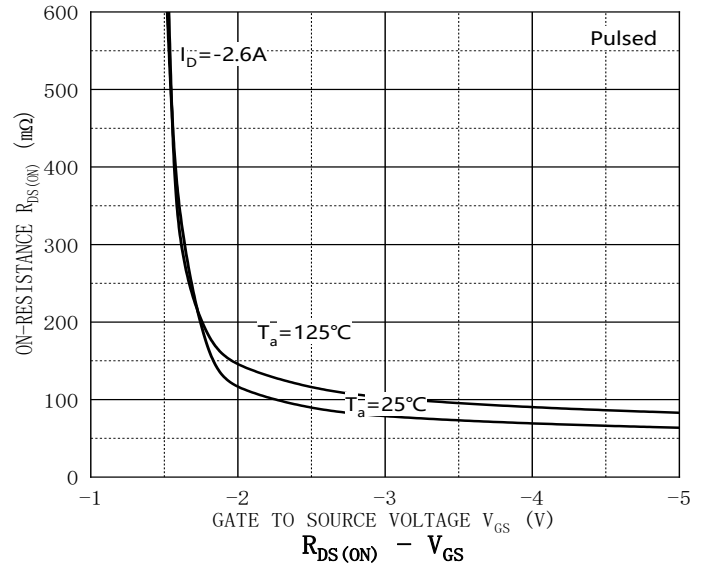
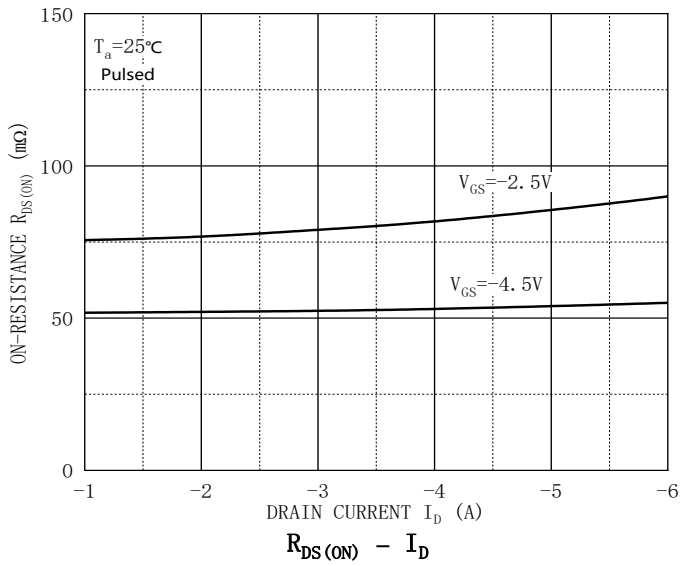
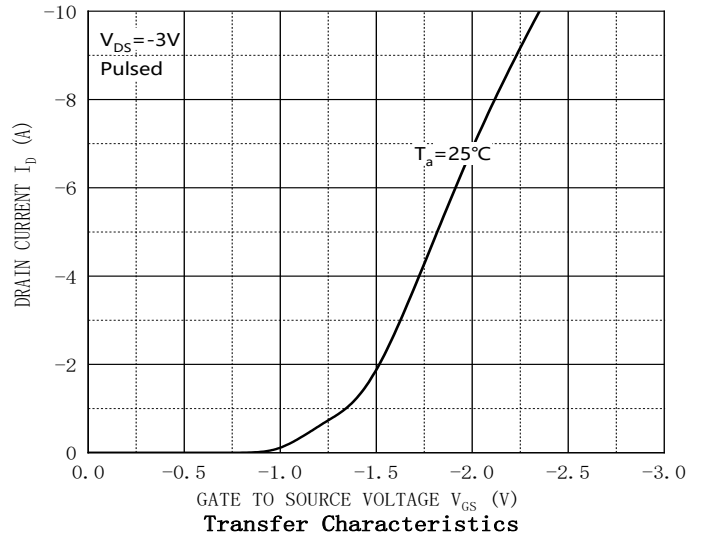
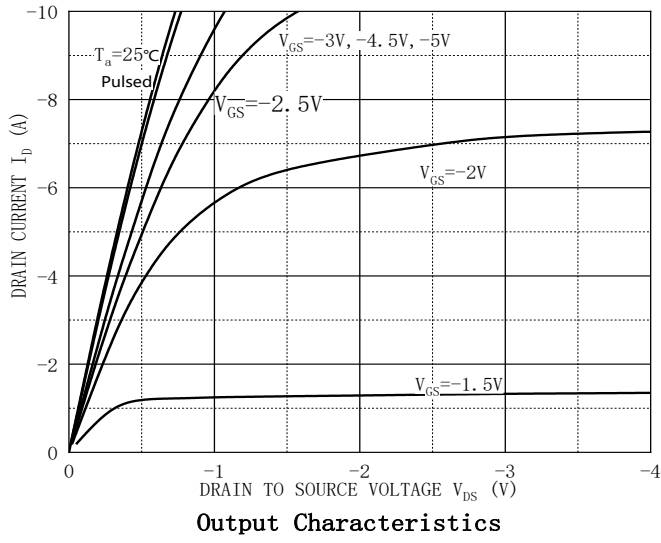
Source-Drain Diode characteristics						
Diode forward voltage	$V_{SD}$	$I_S=1A, V_{GS}=0V$			1.3	V

**Electrical characteristics - P-Channel Q2 ( $T_A=25^\circ C$ , unless otherwise noted)**

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
<b>Static Characteristics</b>						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = -250\mu A$	-20			V
Zero gate voltage drain current	$I_{DSS}$	$V_{DS} = -16V, V_{GS} = 0V$			-1	$\mu A$
Gate-body leakage current	$I_{GSS}$	$V_{GS} = \pm 12V, V_{DS} = 0V$			$\pm 100$	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250\mu A$	-0.5	-0.7	-1	V
Drain-source on-resistance	$R_{DS(on)}$	$V_{GS} = -4.5V, I_D = -3A$		50	60	m $\Omega$
		$V_{GS} = -2.5V, I_D = -1A$		70	90	
<b>Dynamic characteristics</b>						
Input Capacitance	$C_{iss}$	$V_{DS} = -10V, V_{GS} = 0V, f = 1MHz$		405		pF
Output Capacitance	$C_{oss}$			75		
Reverse Transfer Capacitance	$C_{rss}$			55		
Gate resistance	$R_g$	$f = 1MHz$		6		$\Omega$
Total Gate Charge	$Q_g$	$V_{DS} = -10V, V_{GS} = -2.5V, I_D = -3A$		3.3	12	nC
Gate-Source Charge	$Q_{gs}$			0.7		
Gate-Drain Charge	$Q_{gd}$			1.3		
Turn-on delay time	$t_{d(on)}$	$V_{DD} = -10V, V_{GEN} = -4.5V, I_D = -1A$ $R_L = 10\Omega, R_{GEN} = 1\Omega$		11		ns
Turn-on rise time	$t_r$			35		
Turn-off delay time	$t_{d(off)}$			30		
Turn-off fall time	$t_f$			10		
<b>Source-Drain Diode characteristics</b>						
Diode Forward voltage	$V_{SD}$	$V_{GS} = 0V, I_S = -1A$			-1.3	V

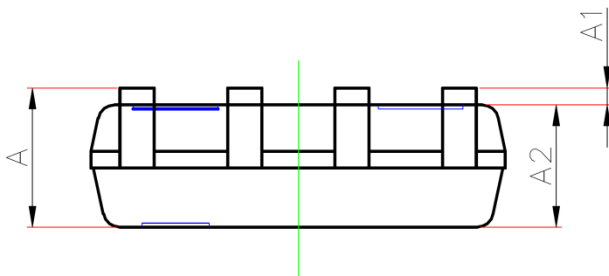
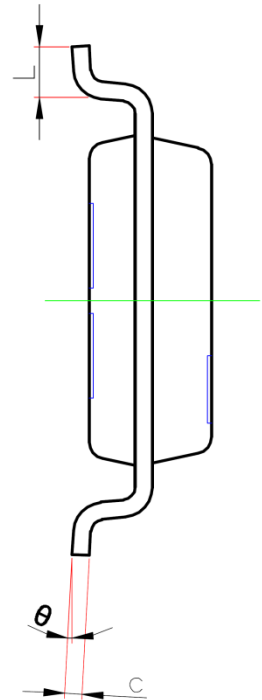
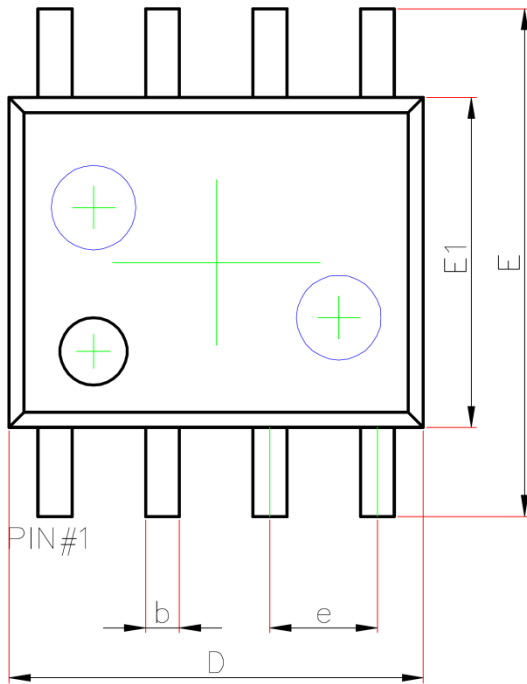
**Typical Characteristics - N-Channel Q1**



**Typical Characteristics - P-Channel Q2**




SOP-8L Package Information



Symbol	Dimensions In Millimeters	
	Min.	Max.
A	1.35	1.75
A1	0.10	0.25
A2	1.35	1.55
b	0.33	0.51
c	0.17	0.25
D	4.80	5.00
e	1.27 REF.	
E	5.80	6.20
E1	3.80	4.00
L	0.40	1.27
$\theta$	0°	8°

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